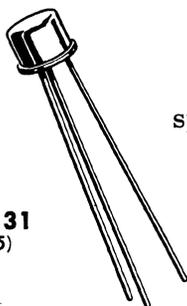


2N3013**2N3014**

For Specifications, See 2N3009 Data.

2N3015 (SILICON)**CASE 31**
(TO-5)

NPN silicon annular transistor designed for high-speed, medium-power saturated switching applications.

Collector connected to case

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage*	V_{CEO}^*	30	Vdc
Collector-Base Voltage	V_{CB}	60	Vdc
Emitter-Base Voltage	V_{EB}	5.0	Vdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	800 4.6	mW mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	3.0 17.2	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200	$^\circ\text{C}$

*Applicable from 1.0 mA to 30 mA (Pulsed)

2N3015 (continued)

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Sustaining Voltage* (I _C = 30 mA, I _B = 0)	BV _{CEO(sus)} *	30	—	Vdc
Collector-Base Breakdown Voltage (I _C = 100 μA, I _E = 0)	BV _{CB0}	60	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 100 μA, I _C = 0)	BV _{EBO}	5.0	—	Vdc
Collector-Cutoff Current (V _{CE} = 30 Vdc, V _{BE} = 0)	I _{CES}	—	0.2	μA
Collector-Cutoff Current (V _{CB} = 30 Vdc, I _E = 0, T _A = 125°C)	I _{CBO}	—	200	μA
Base Leakage Current (V _{CE} = 30 Vdc, V _{BE} = 0)	I _{BL}	—	0.2	μA

ON CHARACTERISTICS

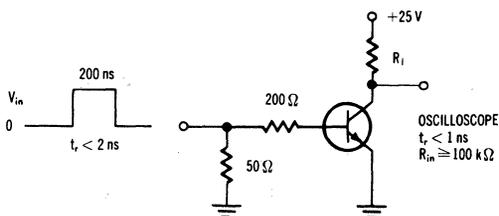
DC Current Gain* (I _C = 150 mA, V _{CE} = 10 Vdc) (I _C = 300 mA, V _{CE} = 0.7 Vdc)	h _{FE} *	30 10	120 —	—
Collector-Emitter Saturation Voltage* (I _C = 150 mA, I _B = 15 mA) (I _C = 500 mA, I _B = 50 mA)	V _{CE(sat)} *	— —	0.4 1.0	Vdc
Base-Emitter Saturation Voltage* (I _C = 150 mA, I _B = 15 mA) (I _C = 500 mA, I _B = 50 mA)	V _{BE(sat)} *	— —	1.2 1.6	Vdc

DYNAMIC CHARACTERISTICS

Current-Gain-Bandwidth Product (I _C = 50 mA, V _{CE} = 10 Vdc, f = 100 MHz)	f _T	250	—	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 140 kHz)	C _{ob}	—	8.0	pF
Turn-On Time (Figure 1) (V _{CC} = 25 Vdc, I _C ≈ 300 mA, I _{B1} ≈ 30 mA) (V _{CC} = 25 Vdc, I _C ≈ 500 mA, I _{B1} ≈ 50 mA)	t _{on}	— —	40 40	ns
Turn-Off Time (Figure 2) (V _{CC} = 25 Vdc, I _C ≈ 300 mA, I _{B1} ≈ I _{B2} = 30 mA) (V _{CC} = 25 Vdc, I _C ≈ 500 mA, I _{B1} ≈ I _{B2} = 50 mA)	t _{off}	— —	60 60	ns

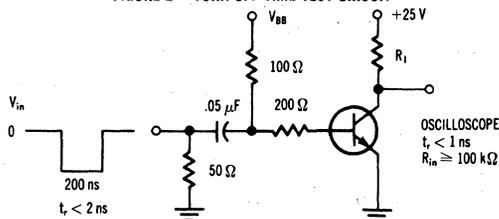
*Pulse Test: Pulse Width = 300 μs; Duty Cycle ≤ 2%

FIGURE 1 — TURN-ON TIME TEST CIRCUIT



I _C mA	V _{in} Volts	R _i ohms
300	7.0	80
500	11	48

FIGURE 2 — TURN-OFF TIME TEST CIRCUIT



I _C mA	V _{in} Volts	V _{BB} Volts	R _i ohms
300	-13	10	80
500	-21	16	48